DATA SHEET

PHOTOCOUPLERS PS8602, PS8602L

HIGH NOISE REDUCTION HIGH SPEED ANALOG OUTPUT TYPE 8 PIN PHOTOCOUPLER

DESCRIPTION

NEC

PS8602 and PS8602L is a 8-pin high speed photocoupler containing a GaAlAs LED on input side and a P-N photodiode and a high speed amplifier transistor on output side on one chip. PS8602 is in a plastic DIP (Dual In-line Package). PS8602L is lead bending type (Gull wing) for surface mount.

FEATURES

- High common mode transient immunity (OMR, OML: ±2000 V/µs MIN.)
- High supply voltage (Vcc = 35 V MAX.)
- High speed response (tphL, tpLH: 0.8 μs MAX.)
- High isolation voltage (BV: 5 000 Vr.m.s. MIN.)
- TTL, CMOS compatible with a resistor
- Taping product number (PS8602L-E3)
- UL recognized [File No. E72422(s)]
- VDE0884 recognized: option

APPLICATIONS

- Interface circuit for various instrumentations, control equipments.
- Computer and peripheral manufactures.

ORDERING INFORMATION

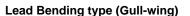
PART NUMBER	PACKAGE	SAFETY STANDARD APPROVAL			
PS8602	8 pin DIP	Normal specification products			
PS8602L	8 pin DIP, lead bending type	UL Approved			
PS8602L1	8 pin DIP, lead bending type				
PS8602L2	(for long distance)				
PS8602-V	8 pin DIP	VDE0884 specification products (option)			
PS8602L-V	8 pin DIP, lead bending type	VDE Approved			
PS8602L1-V	8 pin DIP, lead bending type				
PS8602L2-V	(for long distance)				

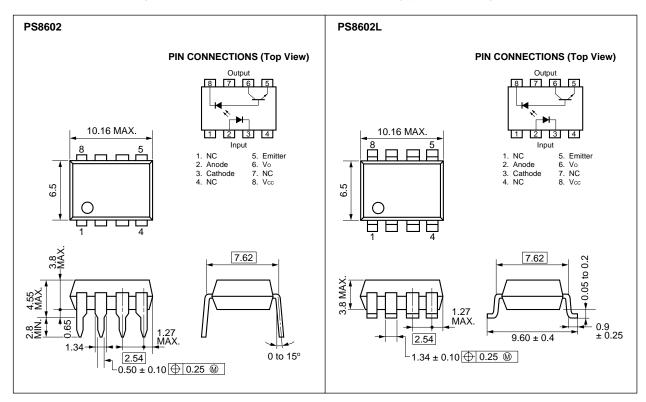
[Handling Precaution]

This product is weak for static electricity by designed with high speed integrated circuit. So, protect against static electricity when handling.

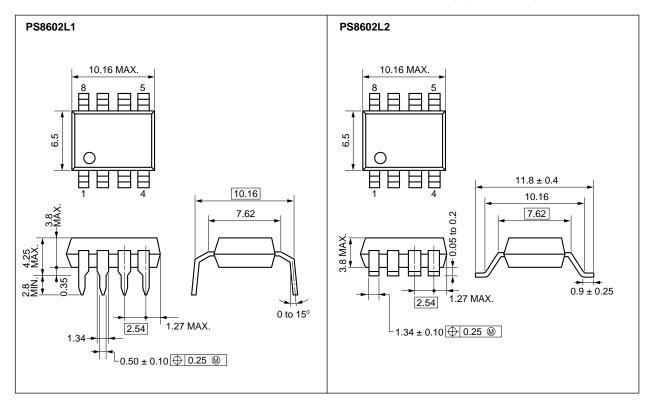
PACKAGE DIMENSIONS (Unit: mm)

DIP (Dual In-line Package)





Lead Bending type (for long distance)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \ ^{\circ}C$)

Diode			
Forward Current	lf	25	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	45	mW
Detector			
Supply Voltage	Vcc	35	V
Output Voltage	Vo	35	V
Output Current	lo	8	mA
Power Dissipation	Pc	100	mW
Isolation Voltage ^{*1}	BV	5 000	Vr.m.s.
Operating Temperature	TA	-55 to +100	°C
Storage Temperature	Tstg	-55 to +150	°C

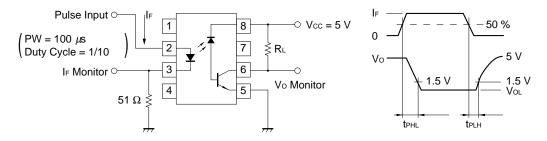
*1 AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output.

ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

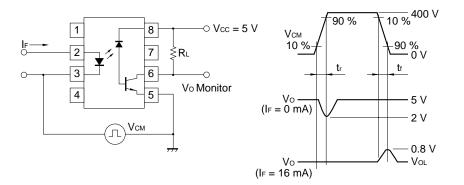
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Diode	Forward Voltage	VF		1.7	2.2	V	l⊧ = 16 mA
	Reverse Current	IR			10	μA	V _R = 5 V
	Forward Voltage Temperature Coefficient	<u>⊿V</u> ғ_ ⊿Т		-1.6		mV/°C	lF = 16 mA
	Junction Capacitance	Ct		60		pF	V = 0, f = 1 MHz
Detector	High Level Output Current	Іон 1		3	500	nA	$I_F = 0 \text{ mA}, \text{ Vcc} = \text{Vo} = 5.5 \text{ V}$
	High Level Output Current	Іон 2			100	μA	IF = 0 mA, Vcc = Vo = 35 V
	Low Level Output Voltage	Vol		0.1	0.4	V	IF = 16 mA, Vcc = 4.5 V, Io = 1.2 mA
	Low Level Supply Current	lcc∟		50		μA	IF = 16 mA, Vo = Open, Vcc = 35 V
	High Level Supply Current	Іссн		0.01	1	μA	$I_F = 0 \text{ mA}, \text{ Vo} = \text{Open}, \text{ Vcc} = 35 \text{ V}$
Coupler	Current Transfer Ratio	CTR	15			%	IF = 16 mA, Vcc = 4.5 V, Vo = 0.4 V
	Isolation Resistance	R1-2	10 ¹¹			Ω	Vin-out = 1 kVDC
	Isolation Capacitance	C1-2		0.7		pF	V = 0, f = 1 MHz
	$\begin{array}{l} \mbox{Propagation Delay Time} \\ \mbox{(H} \rightarrow \mbox{L}) & \mbox{*2} \end{array}$	tph∟		0.5	0.8	μS	IF = 16 mA, Vcc = 5 V RL = 1.9 kΩ
	$\begin{array}{ll} \mbox{Propagation Delay Time} \\ \mbox{(L} \rightarrow \mbox{H}) & \mbox{*2} \end{array}$	tрLн		0.3	0.8	μs	IF = 16 mA, Vcc = 5 V RL = 1.9 kΩ
	Common mode transient immunity at high level output *3	СМн	2 000			V/µs	IF = 0 mA, Vcm = 400 V RL = 4.1 kΩ
	Common mode transient immunity at low level output *3	CM∟	-2 000			V/µs	IF = 16 mA, VCM = 400 V RL = 4.1 kΩ

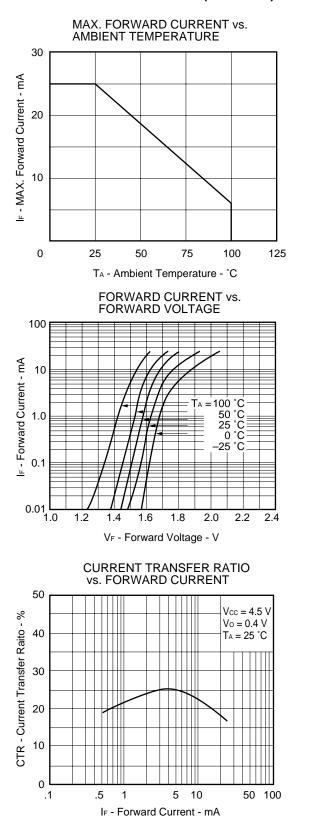
*2 Test Circuit for Propagation Delay Time.

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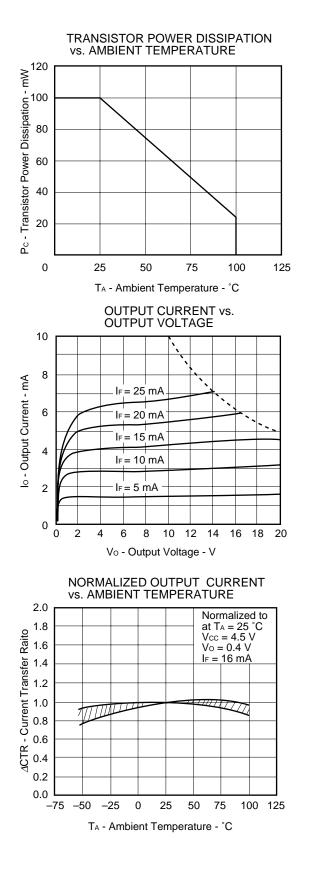


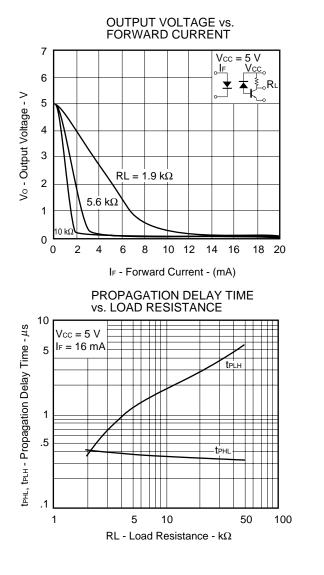
*3 Test Circuit for Common mode transient immunity

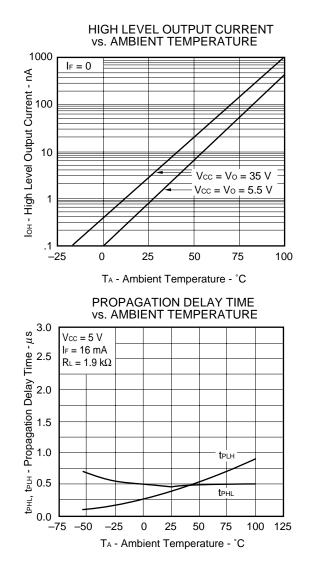




TYPICAL CHARACTERISTICS (TA = 25 °C)

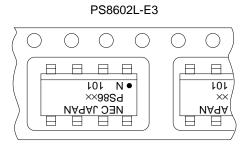




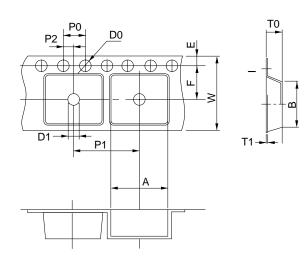


TAPING

1. TAPING DIRECTION

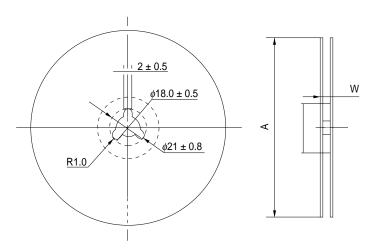


2. OUTLINE AND DIMENSIONS (TAPE)



	Unit: mm		
SYMBOL	RATINGS		
А	10.7 ± 0.1		
В	10.3 ± 0.1		
D0	1.55 ± 0.1		
D1	1.55 ± 0.1		
ш	1.75 ± 0.1		
F	7.5 ± 0.1		
P0	4.0 ± 0.1		
P1	12.0 ± 0.1		
P2	$\textbf{2.0}\pm\textbf{0.1}$		
T0	4.3 ± 0.2		
T1	0.3		
W	16 ± 0.3		

3. OUTLINE AND DIMENSIONS (REEL)



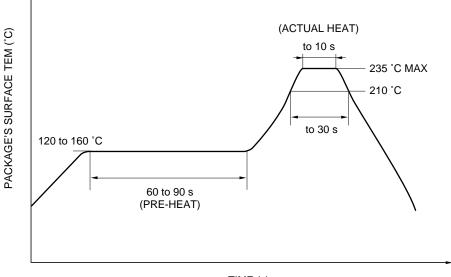
	Unit: mm			
SYMBOL	RATINGS			
А	330			
Ν	80 ± 5.0			
W	$16.4^{+2.0}_{-0}$			

4. PACKING; 1000 pieces/reel

SOLDERING PRECAUTION

- (1) Infrared reflow soldering
 - Peak temperature : 235 °C or lower (plastic surface)
 - Time : 30 s or less
 - (Time during plastic surface temperature overs 210 °C)
 - No. of reflow times : Three
 - Flux
 : Rosin-base flux

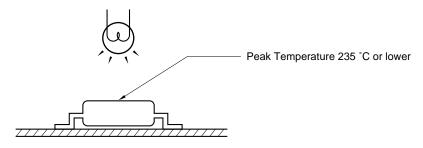




TIME (s)

<NOTES>

(1) Please avoid be removed the residual flux by water after the first reflow processes.



(2) Dip soldering

- Peak temperature : 260 °C or lower
- Time : 10 s or less
- Flux : Rosin-base flux

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT (VDE0884)

PARAMETER	SYMBOL	SPECK	UNIT
Application classification (DIN VDE0109) for rated line voltages \leq 300 V _{eff} for rated line voltages \leq 600 V _{eff}		IV III	
Climatic test class (DIN IEC 68 Teil 1/09.80)		55/100/21	
Dielectric strength maximum operating isolation voltage. Test voltage (partial discharge test procedure a for type test and random test) $U_{pr} = 1.2 \times U_{IORM}$, Pd < 5 pC	UIORM Upr	890 1 068	V _{peak} V _{peak}
Test voltage (partial discharge test procedure b for random test) U_{Pr} = 1.6 $ imes$ UIORM, Pd < 5 pC	Upr	1 424	Vpeak
Highest permissible overvoltage	Utr	8 000	Vpeak
Degree of pollution (DIN VDE0109)		2	
Clearance distance		> 7.0	mm
Creepage distance		> 7.0	mm
Comparative tracking index (DIN IEC 112/VDE0303 part 1)	CTI	175	
Material group (DIN VDE0109)		Illa	
Storage temperature range	Tstg	-55 to +150	Cel
Operating temperature range	Tamb	-55 to +100	Cel
Isolation resistance, minimum value Ulo = 500 V dc at 25 Cel Ulo = 500 V dc at Tamp maximum at least 100 Cel	Ris min Ris min	10 ¹² 10 ¹¹	ohm ohm
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation) Isolation resistance	Tsi Isi Psi	175 400 700	Cel mA mW
Uio = 500 V dc at 175 Cel (Tsi)	Ris min	10 ⁹	ohm

CAUTION

The Great Care must be taken in dealing with the devices in this guide. The reason is that the material of the devices is GaAs (Gallium Arsenide), which is designated as harmful substance according to the law concerned. Keep the law concerned and so on, especially in case of removal.

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NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.

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